



NO.	MATERIAL	FINISH	REMARKS	NO.	MATERIAL	FINISH	REMARKS
3	COPPER ALLOY		CONTACT AREA:GOLD 0.1 μm LEAD AREA:GOLD 0.03 μm UNDER PLATING:NICKEL 1.3 μm	7	POLYIMIDE		(TAPE FOR VACUUM PICKUP)
2	POLYAMIDE		BLACK UL94V-0	6	POLYSTYRENE		(TRAY)
1	POLYAMIDE		BLACK UL94V-0	5	BRASS		LEAD AREA:TIN-PLATING 3 μm UNDER PLATING:NICKEL 1 μm
				4	COPPER ALLOY		CONTACT AREA:GOLD 0.1 μm LEAD AREA:TIN-PLATING 1 μm UNDER PLATING:NICKEL 1.3 μm

UNITS	SCALE	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
mm	2:1	4	DIS-F-00001099	TS.00NO	KN.SHIBUYA	16.02.17
APPROVED : HS. OKAWA			14.05.13	DRAWING NO. EDC-353542-00-00		
CHECKED : KN. SHIBUYA			14.05.13	PART NO. FX23-120P-0.5SV15		
DESIGNED : TS.00NO			14.05.13	CODE NO. CL573-3006-4-00		
DRAWN : TS.00NO			14.05.13			